

Specification

MATERIAL:

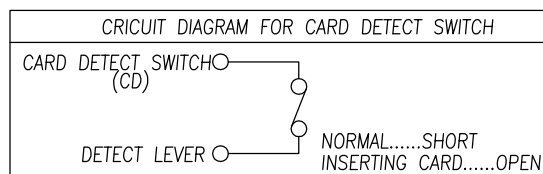
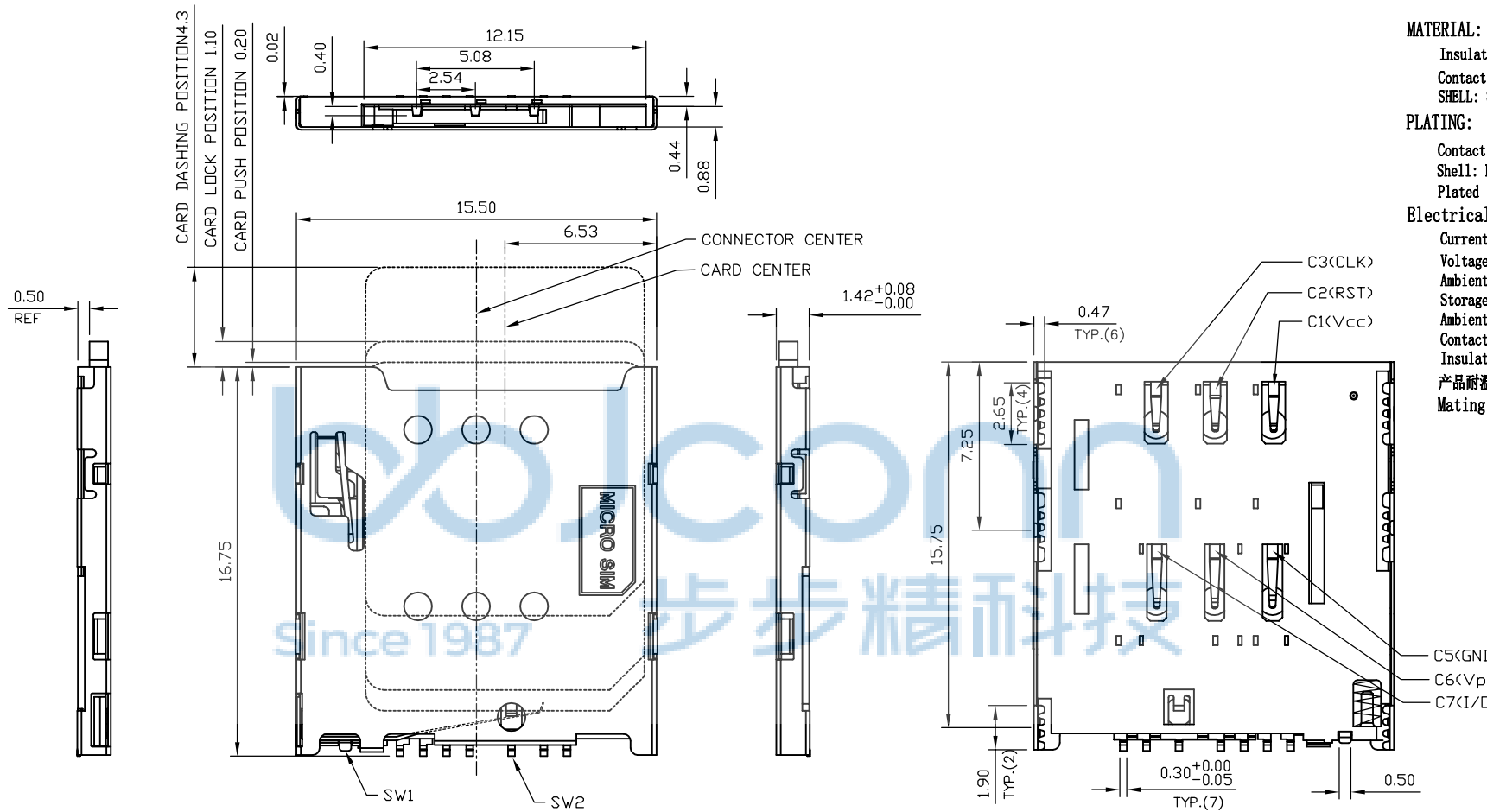
Insulator: High Temperature Thermoplastic, UL 94V-0.
Contact: Copper Alloy
SHELL: SUS

PLATING:

Contact: Plated 50u'' Ni Overall Contact Au 1U
Shell: Plated 50u'' Ni Overall
Plated 1u''Au Selective Contact Area

Electrical:

Current Rating :0.5A AC/DC max.
Voltage Rating :125V AC/DC
Ambient Temperature Range :-20° C~+60° C
Storage Temperature Range :-40° C~+70° C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100m max. Ω
Insulation Resistance:1000M min./500VDC
产品耐温温度: 260
Mating Cycles:3000Min Insertions



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.X: ±0.38 .XX: ±0.25 .XXX: ±0.13	X': ±3' .X': ±2' .XX': ±1'	NAME: MICRO SIM PUSH 7+1P 抽屉式 H=1.42 防呆	
APPD. JM_Zheng	CHKD. LYX	PJ. NO.: 142-208-080001-X8G	
DR. SGF	PDWG.NO: 0214-1	SIZE: A4 DRW NO.:	
		FINISH: SEE NOTES MAT'L.: SEE NOTES	
		SCALE: N/A REV.: A0 UNIT: mm PAGE: 1/3	

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	SGF

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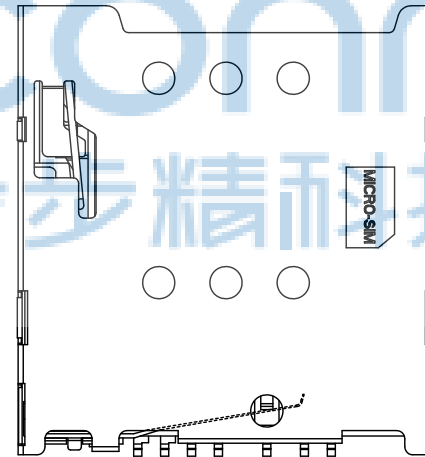
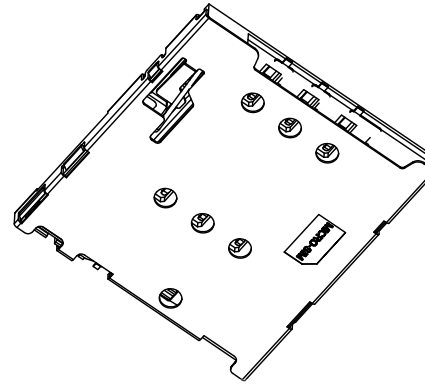
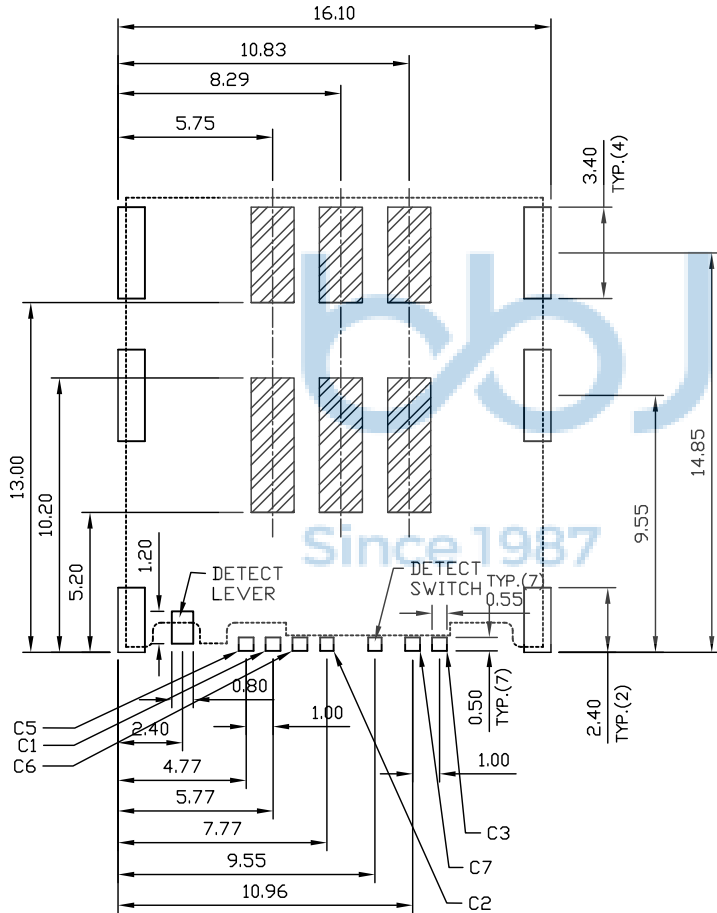
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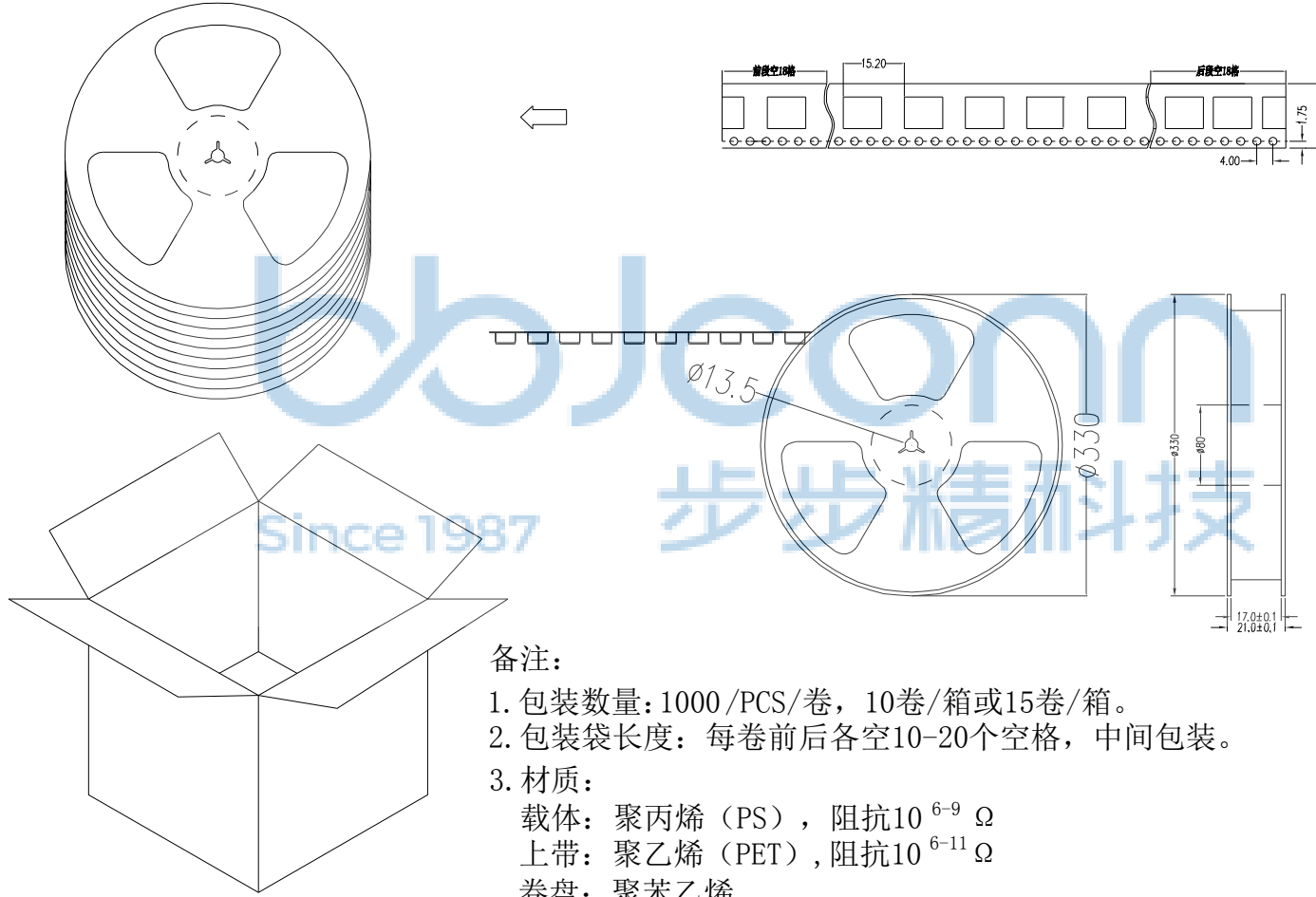
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备注:

1. 包装数量: 1000/PCS/卷, 10卷/箱或15卷/箱。
2. 包装袋长度: 每卷前后各空10-20个空格, 中间包装。
3. 材质:
载体: 聚丙烯 (PS), 阻抗 $10^{6-9} \Omega$
上带: 聚乙烯 (PET), 阻抗 $10^{6-11} \Omega$
卷盘: 聚苯乙烯。

纸箱规格: 345*345*23MM

纸箱规格: 345*345*35MM

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